# **Technical Data Sheet**

# **1206** Package Chip Infrared LED With Inner Lens

### Features

- High reliability
- Small double-end package
- Peak wavelength  $\lambda$  p=850nm
- Package in 8mm tape on 7" diameter reel
- Low forward voltage
- Pb free
- The product itself will remain within RoHS compliant version.

### Descriptions

HIR11-21C/L11/TR8 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic With flat top view lens. The device is spectrally matched with silicon photodiode

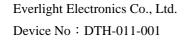
and phototransistor.

### Applications

- PCB mounted infrared sensor
- Infrared remote control units with high power requirement
- Smoke detector
- Infrared applied system

### **Device Selection Guide**

| LED Part No. | Chip<br>Material | Lens Color  |  |
|--------------|------------------|-------------|--|
| HIR          | GaAlAs           | Water clear |  |



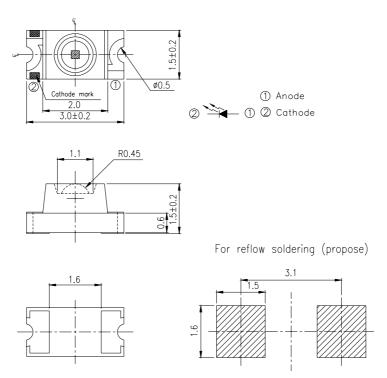
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HIR11-21C/L11/TR8



### **Package Dimensions**



**Notes:** 1.All dimensions are in millimeters 2.Tolerances unless dimensions ±0.1mm

#### Absolute Maximum Ratings (Ta=25°C)

| Parameter                      | Symbol           | Rating    | Units |
|--------------------------------|------------------|-----------|-------|
| Continuous Forward Current     | $I_{\rm F}$      | 65        | mA    |
| Peak Forward Current           | I <sub>FP</sub>  | 1.0       | А     |
| Reverse Voltage                | V <sub>R</sub>   | 5         | V     |
| Operating Temperature          | T <sub>opr</sub> | -25 ~ +85 | °C    |
| Storage Temperature            | T <sub>stg</sub> | -40 ~ +85 | °C    |
| Soldering Temperature          | $T_{sol}$        | 260       | °C    |
| Power Dissipation at(or below) | $P_d$            | 130       | mW    |
| 25℃ Free Air Temperature       |                  |           |       |

**Notes:** \*1:I<sub>FP</sub> Conditions--Pulse Width  $\leq$  100  $\mu$  s and Duty  $\leq$  1%.

\*2:Soldering time  $\leq$  5 seconds.

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#### **Electro-Optical Characteristics (Ta=25°C)**

| Parameter             | Symbol             | Condition   | Min. | Typ. | Max. | Units   |  |
|-----------------------|--------------------|---|------|------|------|---------|--|
|                       |                    | I <sub>F</sub> =20mA  | 1.0  | 2.0  |      |         |  |
| Radiant Intensity     | Ee                 | . $I_F\!\!=\!\!100mA$ Pulse Width $\!\leq\!100\mus$ ,Duty $\!\leq\!1\%$ |      | 10   |      | mW /sr  |  |
| Peak Wavelength       | λp                 | I <sub>F</sub> =20mA  |      | 850  |      | nm      |  |
| Spectral<br>Bandwidth | Δλ                 | I <sub>F</sub> =50mA  |      | 45   |      | nm      |  |
|                       | age V <sub>F</sub> | I <sub>F</sub> =20mA  |      | 1.45 | 1.65 |         |  |
| Forward Voltage       |                    | . $I_F\!\!=\!\!100mA$ Pulse Width $\!\leq\!100\mus$ ,Duty $\!\leq\!1\%$ |      | 1.80 | 2.40 | V       |  |
| Reverse Current       | I <sub>R</sub>     | V <sub>R</sub> =5V  |      |      | 10   | $\mu A$ |  |
| View Angle            | 2 <del>0</del> 1/2 | I <sub>F</sub> =20mA  |      | 75   |      | deg     |  |

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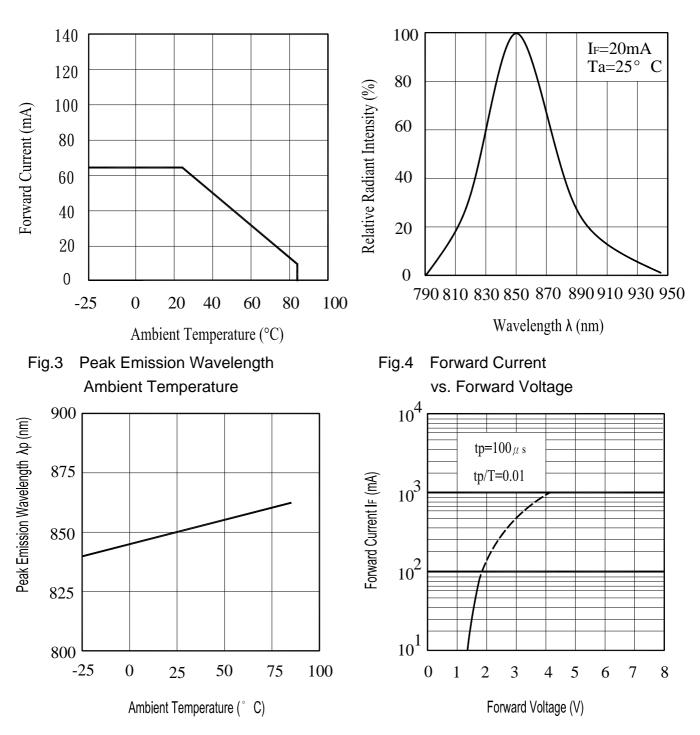


## **Typical Electro-Optical Characteristics Curves**

Fig.1 Forward Current vs.

Fig.2 Spectral Distribution

Ambient Temperature



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 $20^{\circ}$ 

 $30^{\circ}$ 

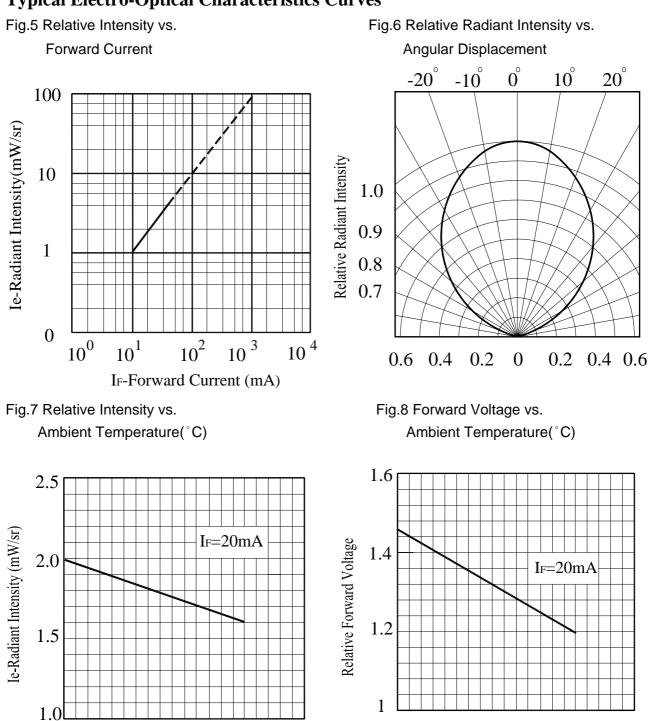
 $40^{\circ}$ 

 $50^{\circ}$ 

 $60^{\circ}$ 

 $70^{\circ}$  $80^{\circ}$ 

### **Typical Electro-Optical Characteristics Curves**



100

120

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50

75

Ambient Temperature(° C)

25

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25

50

75

Ambient Temperature(° C)

Rev 2 Page: 5 of 10 Prepared by : Jaine Tsai

100

120

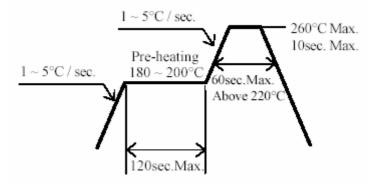


#### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 90% RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 70% RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
  Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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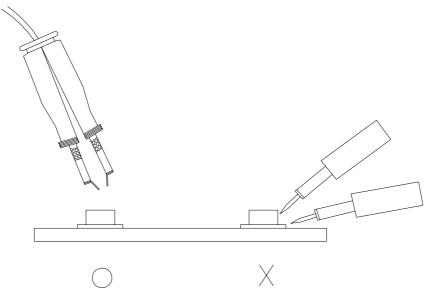


#### 4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $280^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.





#### **Reliability Test Item And Condition**

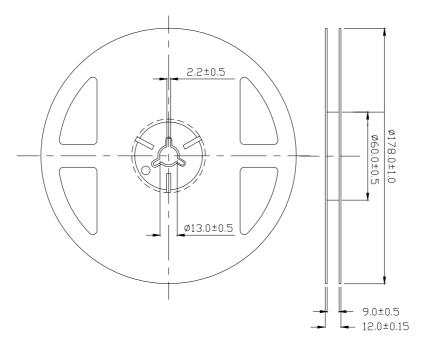
The reliability of products shall be satisfied with items listed below. Confidence level : 90%

LTPD: 10%

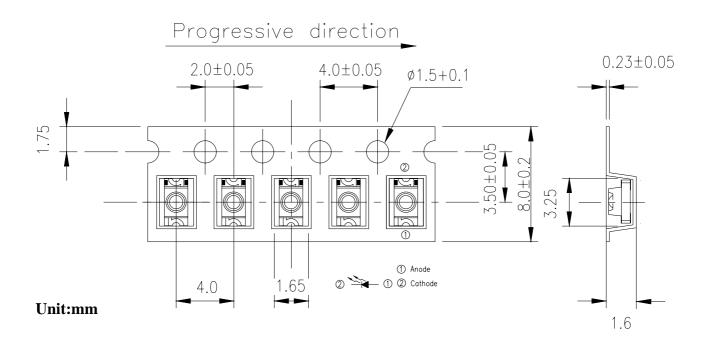
| NO. | Item              | Test Conditions                       | Test Hours/ | Sample | Failure              | Ac/Re |
|-----|-------------------|---------------------------------------|-------------|--------|----------------------|-------|
|     |                   |                                       | Cycles      | Sizes  | Judgement            |       |
|     |                   |                                       |             |        | Criteria             |       |
| 1   | REFLOW Soldering  | TEMP. $: 260^{\circ}C \pm 5^{\circ}C$ | 6Mins       | 22pcs  |                      | 0/1   |
|     |                   | 5secs                                 |             |        | $I_R \ge U \times 2$ |       |
| 2   | Temperature Cycle | H : +100°C 15mins                     | 50Cycles    | 22pcs  | $Ee \leq Lx0.8$      | 0/1   |
|     |                   | 5mins                                 | -           |        | $V_F \ge U x 1.2$    |       |
|     |                   | $L:-40^{\circ}C$ 15mins               |             |        |                      |       |
| 3   | Thermal Shock     | H :+100°C ▲ 5mins                     | 50Cycles    | 22pcs  | U : Upper            | 0/1   |
|     |                   | ▼ 10secs                              | -           |        | Specification        |       |
|     |                   | $L:-10^{\circ}C$ 5mins                |             |        | Limit                |       |
| 4   | High Temperature  | TEMP. ∶ +100°C                        | 1000hrs     | 22pcs  | L: Lower             | 0/1   |
|     | Storage           |                                       |             |        | Specification        |       |
| 5   | Low Temperature   | <b>ТЕМР.</b> : -40°С                  | 1000hrs     | 22pcs  | Limit                | 0/1   |
|     | Storage           |                                       |             |        |                      |       |
| 6   | DC Operating Life | I <sub>F</sub> =20mA                  | 1000hrs     | 22pcs  |                      | 0/1   |
| 7   | High Temperature/ | 85°C / 85% R.H                        | 1000hrs     | 22pcs  |                      | 0/1   |
|     | High Humidity     |                                       |             |        |                      |       |



#### **Package Dimensions**



#### **Taping Dimensions**



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### **Packing Quantity Specification**

 $1.2000 Pcs/1 Volume \ , \ 1 Volume/1 Bag$ 

2.10Boxes/1Carton

### Label Form Specification



CPN: Customer's Production Number P/N : Production Number QTY: Packing Quantity CAT: Ranks HUE: Peak Wavelength REF: Reference LOT No: Lot Number MADE IN TAIWAN: Production Place

#### Notes

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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